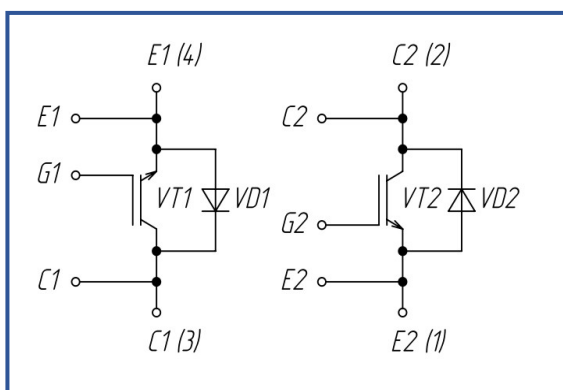
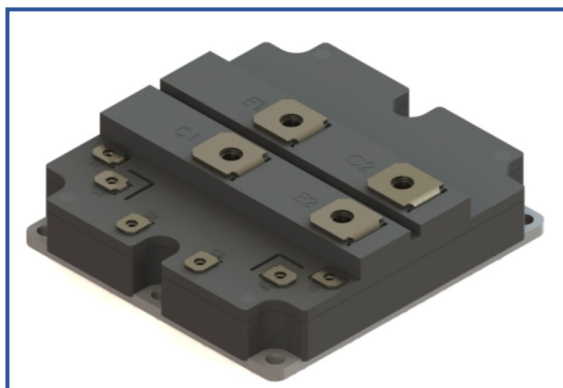


IGBT high-power module
1700 V 1200 A

Chip features

- IGBT chip
 - Trench FS
 - low $V_{CE(sat)}$ value
 - 10 μ s short circuit of 150°C
 - square RBSOA of 2xIC
 - low EMI
- FRD chip
 - fast and soft reverse recovery
 - low voltage drop

Design features

- AlSiC baseplate
- AlN DBC substrate
- ultrasonically welded power terminals

Typical application

- AC and DC motor drives
- high-power converters
- wind-powered generator inverters
- industrial equipment

Maximum rated values

Definition	Symbol	Conditions	Value	Unit
IGBT				
Collector-Emitter voltage	V_{CES}	$V_{GE} = 0$.	1700	V
Maximum allowable collector current (continuous)* ²	$I_{C\ 25}$	$T_{vj\ (max)} = 150^{\circ}C$; $T_c = 25^{\circ}C$.	1899	A
	$I_{C\ 80}$	$T_{vj\ (max)} = 150^{\circ}C$; $T_c = 80^{\circ}C$.	1333	A
Repetitive peak collector current* ¹	I_{CRM}	$I_{CRM} = 2 \times I_{C\ nom}$; $t_p = 1\ ms$.	2400	A
Short-circuit duration	t_{psc}	$T_{vj} = 25^{\circ}C$; $V_{GE} = \pm 15\ V$; $V_{CE} = 1000\ V$; $R_{G\ on} = R_{G\ off} = 0.5\ \Omega$.	10	μs
		$T_{vj} = 150^{\circ}C$; $V_{GE} = \pm 15\ V$; $V_{CE} = 1000\ V$; $R_{G\ on} = R_{G\ off} = 0.5\ \Omega$.	10	
Gate-Emitter voltage	V_{GES}		± 20	V
Junction operating temperature	$T_{vj\ (op)}$		-40...+150	°C
Inverse diode \ Freewheeling diode				
Repetitive peak reverse voltage	V_{RRM}	$V_{GE} = 0\ V$.	1700	V
Maximum allowable forward current (continuous)* ²	$I_{F\ 25}$	$T_{vj\ (max)} = 150^{\circ}C$; $T_c = 25^{\circ}C$.	1295	A
	$I_{F\ 80}$	$T_{vj\ (max)} = 150^{\circ}C$; $T_c = 80^{\circ}C$.	899	A
Repetitive peak forward current* ¹	I_{FRM}	$I_{FRM} = 2 \times I_{F\ nom}$; $t_p = 1\ ms$.	2400	A
Junction operating temperature	$T_{vj\ (op)}$		-40...+150	°C
Module				
Storage temperature	T_{stg}		-40...+60	°C
Isolation voltage	V_{isol}	AC sin 50 Hz; $t = 1\ min$.	4000	V

*¹ Pulse width and repetition rate should be such that device junction temperature does not exceed maximum T_{vj} rating.

*² $I_{C\ 25}$ and $I_{C\ 80}$ ($I_{F\ 25}$ and $I_{F\ 80}$) values were calculated in accordance with typical U_{CE0} , r_{CE0} and $R_{th(j-e)}$ ($U_{(TO)}$, r_T and $R_{th(jc-D)}$).



Characteristics

Definition	Symbol	Conditions	Value			Unit.		
			min.	typ.	max.			
IGBT								
Collector-Emitter saturation voltage	V _{CEsat}	V _{GE} = +15 V; I _C = 1200 A; t _u = 10 μs.	T _{vj} = 25°C	-	1.80	2.20	V	
			T _{vj} = 150°C	-	2.20	2.60	V	
Gate-Emitter threshold voltage	V _{GE(th)}	I _C = 40 mA; U _{CE} = U _{GE} ; T _{vj} = 25°C; t _u = 2 ms.		5.00	6.00	7.00	V	
Collector-Emitter cut-off current	I _{CES}	V _{CE} = 1200 V; t _u = 10 ms; V _{GE} = 0.	T _{vj} = 25°C	-	-	1.00	μA	
			T _{vj} = 150°C	-	-	30.00	mA	
Gate-Emitter leakage current	I _{GES}	V _{CE} = 0; V _{GE} = ±20 V; T _{vj} = 25°C; t _u = const.		-	-	500	nA	
Input capacitance	C _{ies}	V _{CE} = 25 V; V _{GE} = 0 V; f = 100 kHz; T _{vj} = 25°C.		-	109.00	-	nF	
Output capacitance	C _{oes}			-	-	-	nF	
Reverse transfer capacitance	C _{res}			-	3.00	-	nF	
Total gate charge	Q _G	I _C = 1200 A; V _{CE} = 920 V; V _{GE} = -8÷15 V.		-	11.60	-	nC	
Internal gate resistance	R _{Gint}	T _{vj} = 25°C.		-	0.27	-	Ω	
Turn-on delay time	t _{d(on)}	V _{CE} = 900 V; V _{GE} = ±15 V; I _{C max} = 1200 A; R _G = 0.5 Ω; L _s = 150 nH.	T _{vj} = 25°C	-	480	-	ns	
			T _{vj} = 150°C	-	480	-		
Rise time	t _{ri}		T _{vj} = 25°C	-	230	-	ns	
			T _{vj} = 150°C	-	240	-		
Turn-on energy	E _{on}		T _{vj} = 25°C	-	83	-	mJ	
			T _{vj} = 150°C	-	128	-		
Turn-off delay time	t _{d(off)}		T _{vj} = 25°C	-	1200	-	ns	
			T _{vj} = 150°C	-	1280	-		
Fall time	t _{fi}		T _{vj} = 25°C	-	400	-	ns	
			T _{vj} = 150°C	-	490	-		
Turn-off energy	E _{off}		T _{vj} = 25°C	-	570	-	mJ	
			T _{vj} = 150°C	-	660	-		
Collector-emitter threshold voltage	V _{CE0}	V _{GE} = +15 V; T _{vj} = 150°C;		-	0.96	-	V	
On-State slope resistance (IGBT)	r _{CE0}	I _{CE1} = 900 A; I _{CE2} = 1200 A; t _u = 10 μs.		-	1.07	-	mΩ	
Thermal resistance junction to case	R _{th(j-c)}	DC; I _{CE} = 2000±500 A; I _{test} = 3 A; V _{GE} = +15 V.		-	0.0220	-	K/W	
Inverse diode \ Freewheeling diode								
Forward voltage drop	V _F	I _F = 1200 A; V _{GE} = 0; t _u = 10 μs.	T _{vj} = 25°C	-	1.93	-	V	
			T _{vj} = 150°C	-	2.10	-	V	
Reverse recovery time	t _{rr}	V _{GE} = ±15 V; V _{CE} = 900 V; I _{C max} = 1200 A; R _{G on} = 0.5 Ω; L _s = 150 nH.	T _{vj} = 25°C	-	-	-	ns	
			T _{vj} = 150°C	-	-	-	ns	
Peak reverse current	I _{RM}		T _{vj} = 25°C	-	710	-	A	
			T _{vj} = 150°C	-	870	-	A	
Recovered charge	Q _r		T _{vj} = 25°C	-	240	-	μC	
			T _{vj} = 150°C	-	415	-	μC	
Reverse recovery energy	E _{rec}		T _{vj} = 25°C	-	155	-	mJ	
			T _{vj} = 150°C	-	295	-	mJ	
Threshold voltage	V _(T0)	T _{vj} = 150°C; V _{GE} = 0; I _{CE1} = 900 A;		-	0.9	-	V	
Forward slope resistance	r _T	I _{CE2} = 1200 A; t _u = 10 μs		-	1.00	-	mΩ	
Thermal resistance junction to case	R _{th(JC-D)}	DC; I _{CE} = 2000±500 A; I _{test} = 3 A; U _{GE} = +15 V.		-	0.0440	-	K/W	

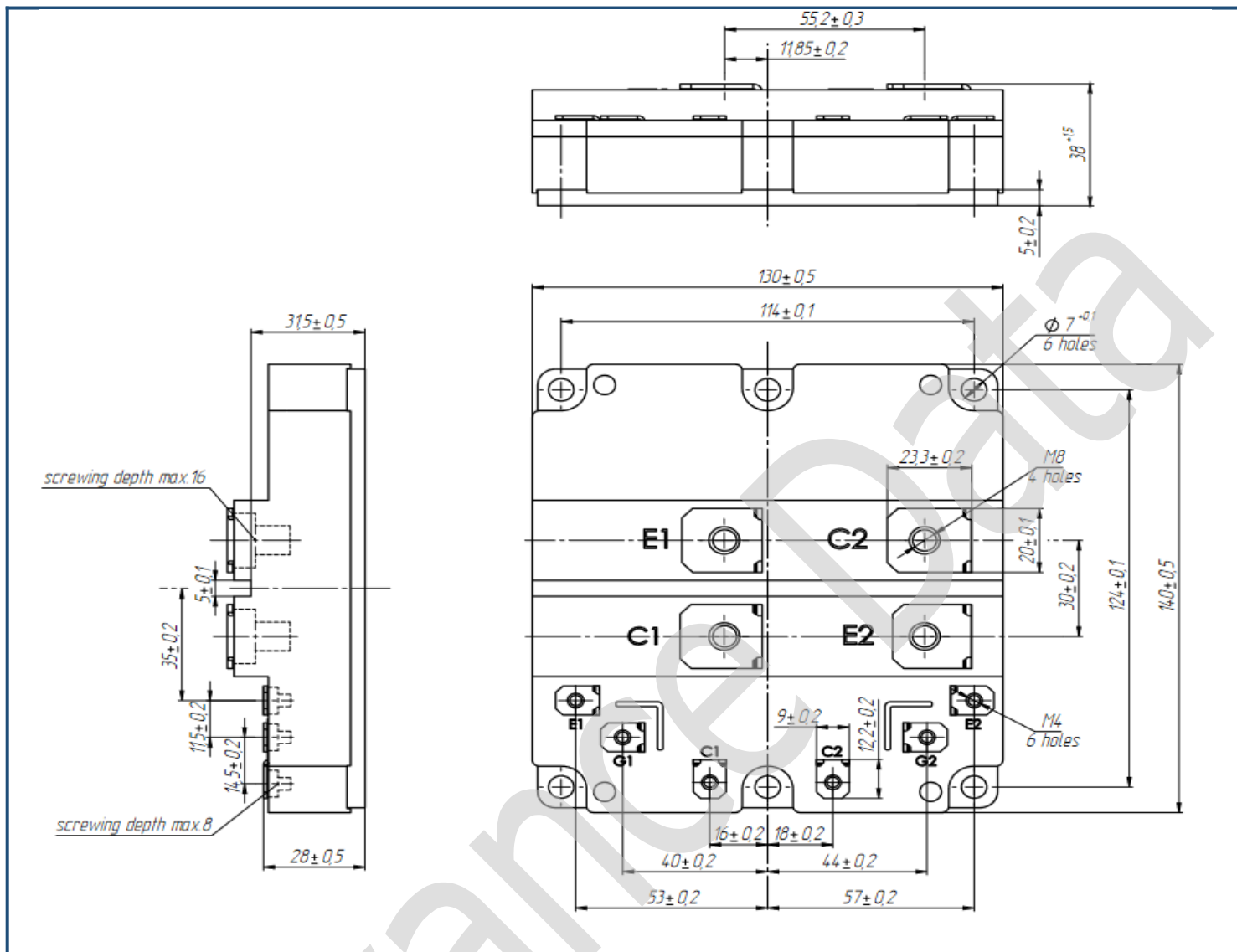
Module							
Pin resistance	R_{Pxy}	$T_{vj} = 25^{\circ}\text{C}.$	$R_{P4-3/1-2}$	-	0.24	-	mΩ
Parasitic inductance between terminals	L_{Pxy}		$L_{P4-3/1-2}$	-	18.00	-	nH
Thermal resistance case to heatsink	R_{thCH}	per module		-	12.00	-	K/W
Mounting torque for screws to heatsink	M_s	to heatsink M6		-	-	5.00	N*m
Mounting torque for screws to control terminal	M_{ct}	to terminals M4		-	-	2.00	N*m
Mounting torque for screws to power terminal	M_{pt}	to terminals M8		-	-	10.00	N*m
Creepage distance	d_s			-	-	15.00	mm
Clearance	d_a			-	-	10.00	mm
Comparative Tracking Index	CTI			-	-	600	
Weight	W			-	-	900	g

“ - ” Data will be refined as additional tests are conducted and statistics are collected.

Notes:

- Insulating material operating temperature 150°C max;
- Case temperature 150°C max;
- The recommended operating junction temperature $T_{vj\text{ op}} = -40 \div +150^{\circ}\text{C}.$

Overall dimensions: Package type – SM



Part numbering guide

MISM	-	DS	17	CA	-	1200	N	
MISM								IGBT module package type: SM
		DS						Double switch
			17					Voltage rating ($V_{CES}/100$)
				CA				IGBT+FRD chipset modification
						1200		Current Rating
							N	Climatic version: normal climate

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